



# B1-24: Fault-Tolerant Techniques for Heterogenous Computing Architectures



**Mission-Critical Computing**  
NSF CENTER FOR SPACE, HIGH-PERFORMANCE,  
AND RESILIENT COMPUTING (SHREC)

SHREC Annual Workshop (SAW23-24)



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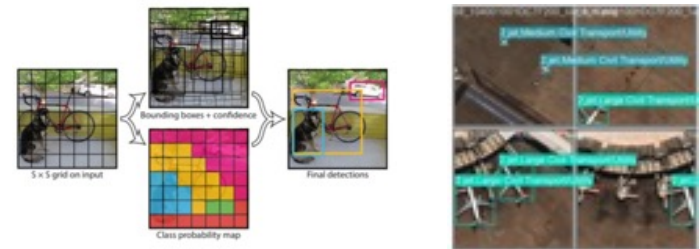
Number of requested memberships  $\geq 4$

# Project Tasks

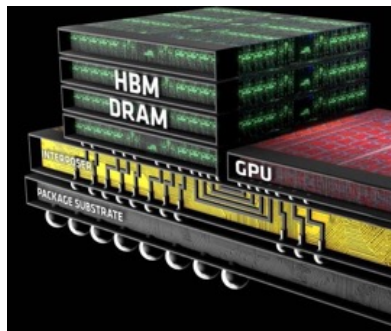
## Task 1: Versal ACAP Reliability



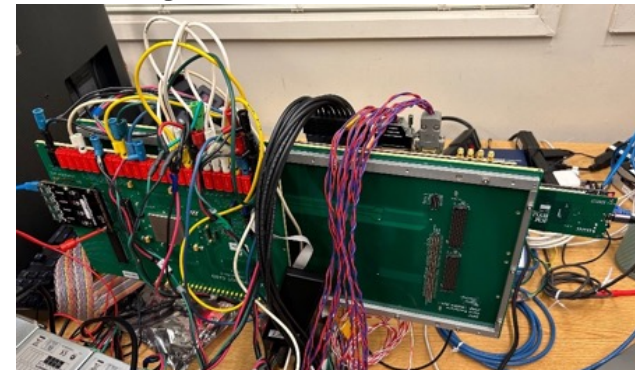
## Task 2: Reliable Deep Learning



## Task 3: High Performance Memory Reliability

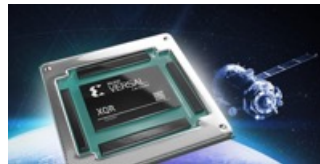


## Task 4: Radiation Testing of Heterogenous Devices



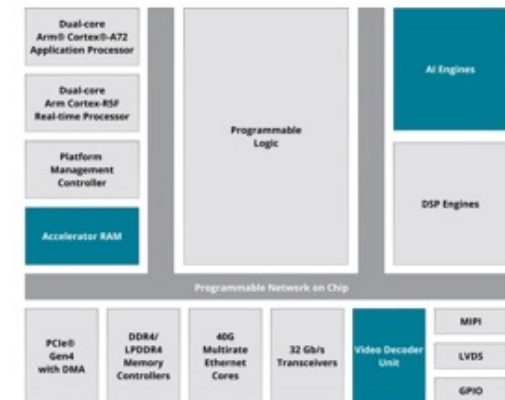
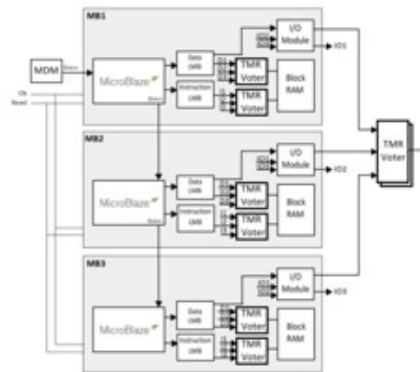
# Task 1 – Versal ACAP Reliability

- AMD announced plans for Versal ACAP devices for space and military applications (XQR Versal)
  - Machine Learning Inference
  - On-board data processing
  - High-speed I/O interfaces
- Support reliability of Versal ACAP Platform
  - Provide documentation and member support for Versal
  - Support scrubbing modes
    - Versal SMAP scrubber
    - XiISEM scrubbing
  - Fault tolerant firmware
  - Support XRTC Versal radiation testing



	XQRVC1902	XQRVE2302
AI Engines	100	17
DSPs	1,968	464
Logic Cells (K)	1,968	329
DDR Controllers	4	1
PL Memory (Mb)	191	86
Gigabit Tx/Rx	44	8

Dual core A72, Dual core R5F, 256 KB OCM

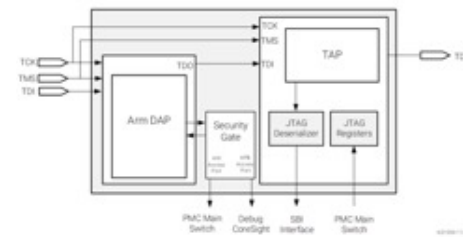


Task 1: Versal ACAP Reliability

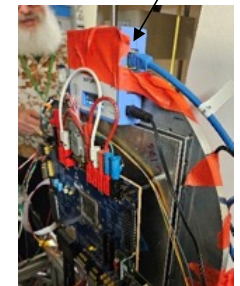


# Versal JCM and Scrubbing Support

- Improved SMAP JCM scrubbing
  - Scrubbing of SMAP/SBI registers
  - Support PLM SMAP timeout and recovery
  - Improve SMAP operating speed
- JCM support for Versal DAP port access
  - Extract processor state much quicker than SmartLynqs
    - Efficient Versal memory extraction essential for radiation testing
    - Read internal memory, processor registers, and PLM state
  - Implement AMD/Xilinx “Hardware Server” in JCM
- High-speed PCIe Scrubbing
  - Perform PCIe scrubbing in bare metal on PolarFire
    - Previously required Linux on PolarFire
  - Integrate PCIe scrubbing on Versal XRTC board



SmartLynq

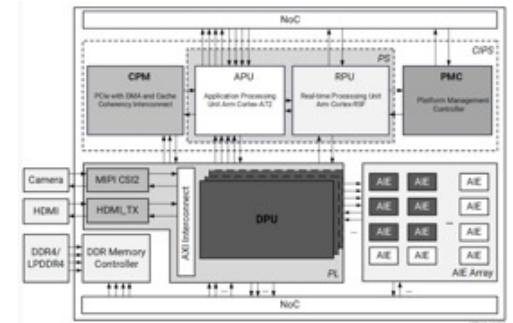
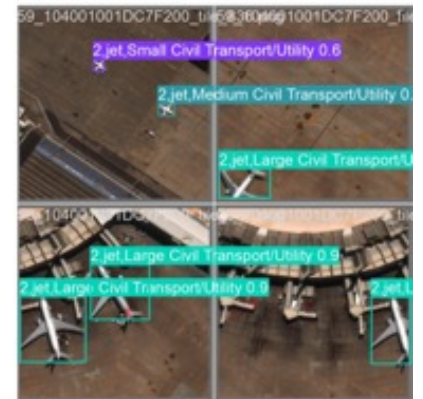




# Task 2 - Reliable Deep Learning

In 2023 we began exploring using the Versal ACAP devices with AI Engines to run machine learning benchmarks. This year:

- Experiment with different DPU configurations
  - DPUCVDX8G has several parameters to determine utilization of AI engines and other hardware resources
  - Evaluate the effect of DPU configurations on throughput and latency of several Yolo models
- Fault Injection & Radiation testing
  - Investigate whether faults can be injected directly into AI engines
  - Use fault injection to investigate the impact on deep learning behaviors
  - Measure the impact to YOLO prediction accuracy
- Investigate custom HDL implementation of YOLO
  - So far we have been using Xilinx/AMD's DPU, which is a configurable hardware IP.
  - We plan to investigate whether we can obtain better performance with a custom hardware design.
- Generate predictions from live camera feed
  - To date, we have been running on static images in memory
  - Creating a full system with a live feed will allow us to perform reliability experiments on a more complete system.



# Bare Metal AI-Engine Designs

Goal: Create bare-metal designs that generate AI-engine traffic

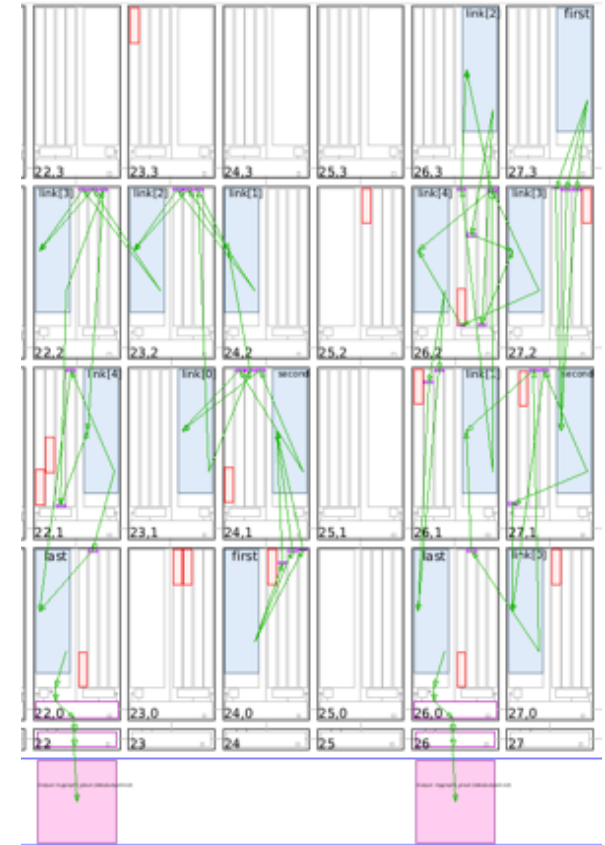
- Provides more fine-tuned control over the AI Engines
- Useful for radiation testing

Approach:

- Incorporate AI Engines into designs with PL and ARM cores
- Use bare metal C/C++ toolchain in Vitis
- HLS is used for hardware kernels in the PL
- Generate designs with various access patterns, throughput, and latency.
- Data can be chained through multiple AI engines to create complex data movement patterns.

We have started testing small designs, and are working to scale to larger systems.

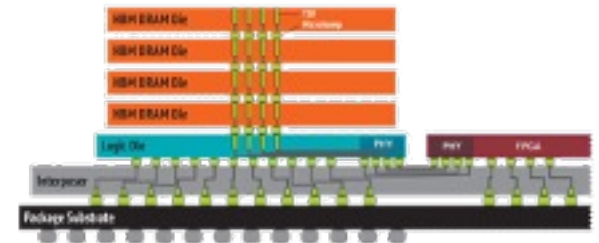
- Example: On the right is a set of two identical and parallel designs, each consisting of a hardware kernel (*pink*) and resources from 8 AI Engines (*blue*). Visuals generated by Vitis Analyzer.



# Task 3 – HBM Reliability and Performance

In 2023 we focused on techniques to warm up HBM FPGAs to use them in below freezing environments. This year:

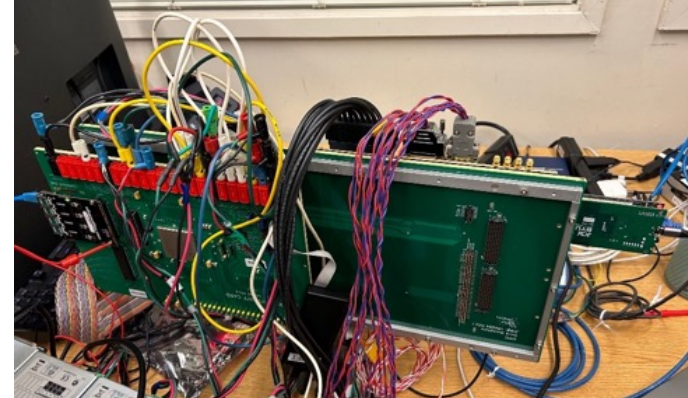
1. Continue exploring HBM in harsh environments
  - Investigate data integrity at different temperatures
2. Benchmarking FPGA HBM performance
  - Investigate performance at different clock rates, sequential vs random accesses, access patterns through the crossbar, in the presence of contention, etc.
  - Test with benchmark applications
- Investigate HBM reliability
  - Perform fault injection on FPGA HBM controller
  - Radiation testing with high-throughput HBM benchmark
    - Capture error rates of HBM
    - Investigate impact of basic parameters (traffic level, number of channels used, etc)
    - Determine whether failure modes observed during fault injection are reproduced in radiation beam





# Task 4 – Radiation Testing

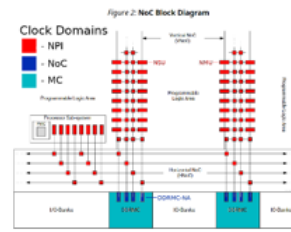
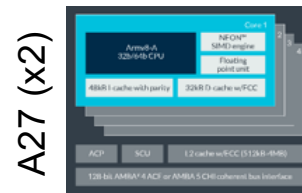
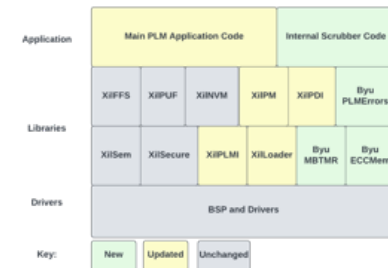
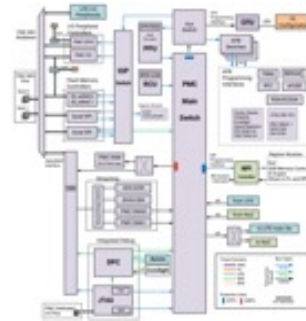
- Radiation testing necessary for understanding complex device failures
  - Identify failure mechanisms and single-event functional interrupts
  - Measure improvement of fault tolerant techniques
- Novel radiation testing methodologies needed for complex heterogeneous devices
  - High-flux testing approaches
  - Simultaneous device testing strategies
  - Low cross-section technologies
- Dedicated tests for Versal
  - Improved Versal firmware
  - Versal AI bare metal testing
  - Linux Versal



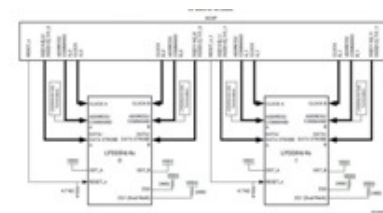


# Versal Radiation Test Experiments

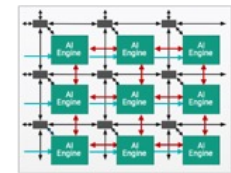
- Versal Firmware Test
  - PLM memory scrubbing
    - Reduce/eliminate PPU hang/failures
    - Facilitate failure recovery
  - PLM Watchdog recovery testing
  - XiISEM “unrecoverable error” recovery
- Versal Processor Testing
  - Active on-chip memory scrubbing
  - DAP controller failure analysis
  - Reliable Linux testing
- Component Testing
  - AI engine reliability
  - NOC reliability
  - DDR controller reliability



NOC



DDR



AIE

## Task 4: Radiation Testing

# Anticipated Radiation Test Experiments

- Berkeley National Laboratory (Heavy Ion)
  - Versal Reliability (multiple components tested)
    - F/T PLM Firmware, F/T Processor support
    - AI engine reliability, NOC reliability
    - High-flux processor testing methodologies
  - Anticipated date: February (likely others)
  
- ChipIR, UK (Neutron)
  - HBM controller reliability
  - Versal Neutron testing
  - Processor testing methodologies
  - Post-radiation fault injection
  - Anticipated date: June (pending proposal)



Lawrence Berkeley  
National Laboratory



# Questions?